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Applications of "Embedded - Microcontrollers"

Details	
Product Status	Active
Core Processor	PIC
Core Size	16-Bit
Speed	32MHz
Connectivity	I²C, PMP, SPI, UART/USART
Peripherals	Brown-out Detect/Reset, LVD, POR, PWM, WDT
Number of I/O	21
Program Memory Size	32KB (11K x 24)
Program Memory Type	FLASH
EEPROM Size	-
RAM Size	8K x 8
Voltage - Supply (Vcc/Vdd)	2V ~ 3.6V
Data Converters	A/D 10x10b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	28-SSOP (0.209", 5.30mm Width)
Supplier Device Package	28-SSOP
Purchase URL	https://www.e-xfl.com/product-detail/microchip-technology/pic24fj32ga002-i-ss

TABLE 1-2: PIC24FJ64GA004 FAMILY PINOUT DESCRIPTIONS (CONTINUED)

Function	Pin Number			I/O	Input Buffer	Description
	28-Pin SPDIP/ SSOP/SOIC	28-Pin QFN	44-Pin QFN/TQFP			
RP0	4	1	21	I/O	ST	Remappable Peripheral.
RP1	5	2	22	I/O	ST	
RP2	6	3	23	I/O	ST	
RP3	7	4	24	I/O	ST	
RP4	11	8	33	I/O	ST	
RP5	14	11	41	I/O	ST	
RP6	15	12	42	I/O	ST	
RP7	16	13	43	I/O	ST	
RP8	17	14	44	I/O	ST	
RP9	18	15	1	I/O	ST	
RP10	21	18	8	I/O	ST	
RP11	22	19	9	I/O	ST	
RP12	23	20	10	I/O	ST	
RP13	24	21	11	I/O	ST	
RP14	25	22	14	I/O	ST	
RP15	26	23	15	I/O	ST	
RP16	—	—	25	I/O	ST	
RP17	—	—	26	I/O	ST	
RP18	—	—	27	I/O	ST	
RP19	—	—	36	I/O	ST	
RP20	—	—	37	I/O	ST	
RP21	—	—	38	I/O	ST	
RP22	—	—	2	I/O	ST	
RP23	—	—	3	I/O	ST	
RP24	—	—	4	I/O	ST	
RP25	—	—	5	I/O	ST	
RTCC	25	22	14	O	—	Real-Time Clock Alarm Output.
SCL1	17	14	44	I/O	I^2C	I2C1 Synchronous Serial Clock Input/Output.
SCL2	7	4	24	I/O	I^2C	I2C2 Synchronous Serial Clock Input/Output.
SDA1	18	15	1	I/O	I^2C	I2C1 Data Input/Output.
SDA2	6	3	23	I/O	I^2C	I2C2 Data Input/Output.
SOSCI	11	8	33	I	ANA	Secondary Oscillator/Timer1 Clock Input.
SOSCO	12	9	34	O	ANA	Secondary Oscillator/Timer1 Clock Output.

Legend: TTL = TTL input buffer ST = Schmitt Trigger input buffer
ANA = Analog level input/output I^2C™ = I^2C/SMBus input buffer

Note 1: Alternative multiplexing when the I2C1SEL Configuration bit is cleared.

TABLE 4-21: PERIPHERAL PIN SELECT REGISTER MAP (PPS)

File Name	Addr	Bit 15	Bit 14	Bit 13	Bit 12	Bit 11	Bit 10	Bit 9	Bit 8	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	All Resets
RPINR0	0680	—	—	—	INT1R4	INT1R3	INT1R2	INT1R1	INT1R0	—	—	—	—	—	—	—	—	1F00
RPINR1	0682	—	—	—	—	—	—	—	—	—	—	—	INT2R4	INT2R3	INT2R2	INT2R1	INT2R0	001F
RPINR3	0686	—	—	—	T3CKR4	T3CKR3	T3CKR2	T3CKR1	T3CKR0	—	—	—	T2CKR4	T2CKR3	T2CKR2	T2CKR1	T2CKR0	1F1F
RPINR4	0688	—	—	—	T5CKR4	T5CKR3	T5CKR2	T5CKR1	T5CKR0	—	—	—	T4CKR4	T4CKR3	T4CKR2	T4CKR1	T4CKR0	1F1F
RPINR7	068E	—	—	—	IC2R4	IC2R3	IC2R2	IC2R1	IC2R0	—	—	—	IC1R4	IC1R3	IC1R2	IC1R1	IC1R0	1F1F
RPINR8	0690	—	—	—	IC4R4	IC4R3	IC4R2	IC4R1	IC4R0	—	—	—	IC3R4	IC3R3	IC3R2	IC3R1	IC3R0	1F1F
RPINR9	0692	—	—	—	—	—	—	—	—	—	—	—	IC5R4	IC5R3	IC5R2	IC5R1	IC5R0	001F
RPINR11	0696	—	—	—	OCFBR4	OCFBR3	OCFBR2	OCFBR1	OCFBR0	—	—	—	OCFAR4	OCFAR3	OCFAR2	OCFAR1	OCFAR0	1F1F
RPINR18	06A4	—	—	—	U1CTSR4	U1CTSR3	U1CTSR2	U1CTSR1	U1CTSR0	—	—	—	U1RXR4	U1RXR3	U1RXR2	U1RXR1	U1RXR0	1F1F
RPINR19	06A6	—	—	—	U2CTSR4	U2CTSR3	U2CTSR2	U2CTSR1	U2CTSR0	—	—	—	U2RXR4	U2RXR3	U2RXR2	U2RXR1	U2RXR0	1F1F
RPINR20	06A8	—	—	—	SCK1R4	SCK1R3	SCK1R2	SCK1R1	SCK1R0	—	—	—	SDI1R4	SDI1R3	SDI1R2	SDI1R1	SDI1R0	1F1F
RPINR21	06AA	—	—	—	—	—	—	—	—	—	—	—	SS1R4	SS1R3	SS1R2	SS1R1	SS1R0	001F
RPINR22	06AC	—	—	—	SCK2R4	SCK2R3	SCK2R2	SCK2R1	SCK2R0	—	—	—	SDI2R4	SDI2R3	SDI2R2	SDI2R1	SDI2R0	1F1F
RPINR23	06AE	—	—	—	—	—	—	—	—	—	—	—	SS2R4	SS2R3	SS2R2	SS2R1	SS2R0	001F
RPOR0	06C0	—	—	—	RP1R4	RP1R3	RP1R2	RP1R1	RP1R0	—	—	—	RP0R4	RP0R3	RP0R2	RP0R1	RP0R0	0000
RPOR1	06C2	—	—	—	RP3R4	RP3R3	RP3R2	RP3R1	RP3R0	—	—	—	RP2R4	RP2R3	RP2R2	RP2R1	RP2R0	0000
RPOR2	06C4	—	—	—	RP5R4	RP5R3	RP5R2	RP5R1	RP5R0	—	—	—	RP4R4	RP4R3	RP4R2	RP4R1	RP4R0	0000
RPOR3	06C6	—	—	—	RP7R4	RP7R3	RP7R2	RP7R1	RP7R0	—	—	—	RP6R4	RP6R3	RP6R2	RP6R1	RP6R0	0000
RPOR4	06C8	—	—	—	RP9R4	RP9R3	RP9R2	RP9R1	RP9R0	—	—	—	RP8R4	RP8R3	RP8R2	RP8R1	RP8R0	0000
RPOR5	06CA	—	—	—	RP11R4	RP11R3	RP11R2	RP11R1	RP11R0	—	—	—	RP10R4	RP10R3	RP10R2	RP10R1	RP10R0	0000
RPOR6	06CC	—	—	—	RP13R4	RP13R3	RP13R2	RP13R1	RP13R0	—	—	—	RP12R4	RP12R3	RP12R2	RP12R1	RP12R0	0000
RPOR7	06CE	—	—	—	RP15R4	RP15R3	RP15R2	RP15R1	RP15R0	—	—	—	RP14R4	RP14R3	RP14R2	RP14R1	RP14R0	0000
RPOR8	06D0	—	—	—	RP17R4(1)	RP17R3(1)	RP17R2(1)	RP17R1(1)	RP17R0(1)	—	—	—	RP16R4(1)	RP16R3(1)	RP16R2(1)	RP16R1(1)	RP16R0(1)	0000
RPOR9	06D2	—	—	—	RP19R4(1)	RP19R3(1)	RP19R2(1)	RP19R1(1)	RP19R0(1)	—	—	—	RP18R4(1)	RP18R3(1)	RP18R2(1)	RP18R1(1)	RP18R0(1)	0000
RPOR10	06D4	—	—	—	RP21R4(1)	RP21R3(1)	RP21R2(1)	RP21R1(1)	RP21R0(1)	—	—	—	RP20R4(1)	RP20R3(1)	RP20R2(1)	RP20R1(1)	RP20R0(1)	0000
RPOR11	06D6	—	—	—	RP23R4(1)	RP23R3(1)	RP23R2(1)	RP23R1(1)	RP23R0(1)	—	—	—	RP22R4(1)	RP22R3(1)	RP22R2(1)	RP22R1(1)	RP22R0(1)	0000
RPOR12	06D8	—	—	—	RP25R4(1)	RP25R3(1)	RP25R2(1)	RP25R1(1)	RP25R0(1)	—	—	—	RP24R4(1)	RP24R3(1)	RP24R2(1)	RP24R1(1)	RP24R0(1)	0000

Legend: — = unimplemented, read as '0'. Reset values are shown in hexadecimal.

Note 1: These bits are only available on 44-pin devices; otherwise, they read as '0'.

5.0 FLASH PROGRAM MEMORY

Note: This data sheet summarizes the features of this group of PIC24F devices. It is not intended to be a comprehensive reference source. For more information, refer to the *"PIC24F Family Reference Manual"*, **"Program Memory"** (DS39715).

The PIC24FJ64GA004 family of devices contains internal Flash program memory for storing and executing application code. The memory is readable, writable and erasable when operating with VDD over 2.25V.

Flash memory can be programmed in three ways:

- In-Circuit Serial Programming™ (ICSP™)
- Run-Time Self-Programming (RTSP)
- Enhanced In-Circuit Serial Programming (Enhanced ICSP)

ICSP allows a PIC24FJ64GA004 family device to be serially programmed while in the end application circuit. This is simply done with two lines for the programming clock and programming data (which are named PGCx and PGDx, respectively), and three other lines for power (VDD), ground (VSS) and Master Clear ($\overline{MCLR}$). This allows customers to manufacture boards with unprogrammed devices and then program the microcontroller just before shipping the product. This also allows the most recent firmware or a custom firmware to be programmed.

RTSP is accomplished using TBLRD (Table Read) and TBLWT (Table Write) instructions. With RTSP, the user may write program memory data in blocks of 64 instructions (192 bytes) at a time and erase program memory in blocks of 512 instructions (1536 bytes) at a time.

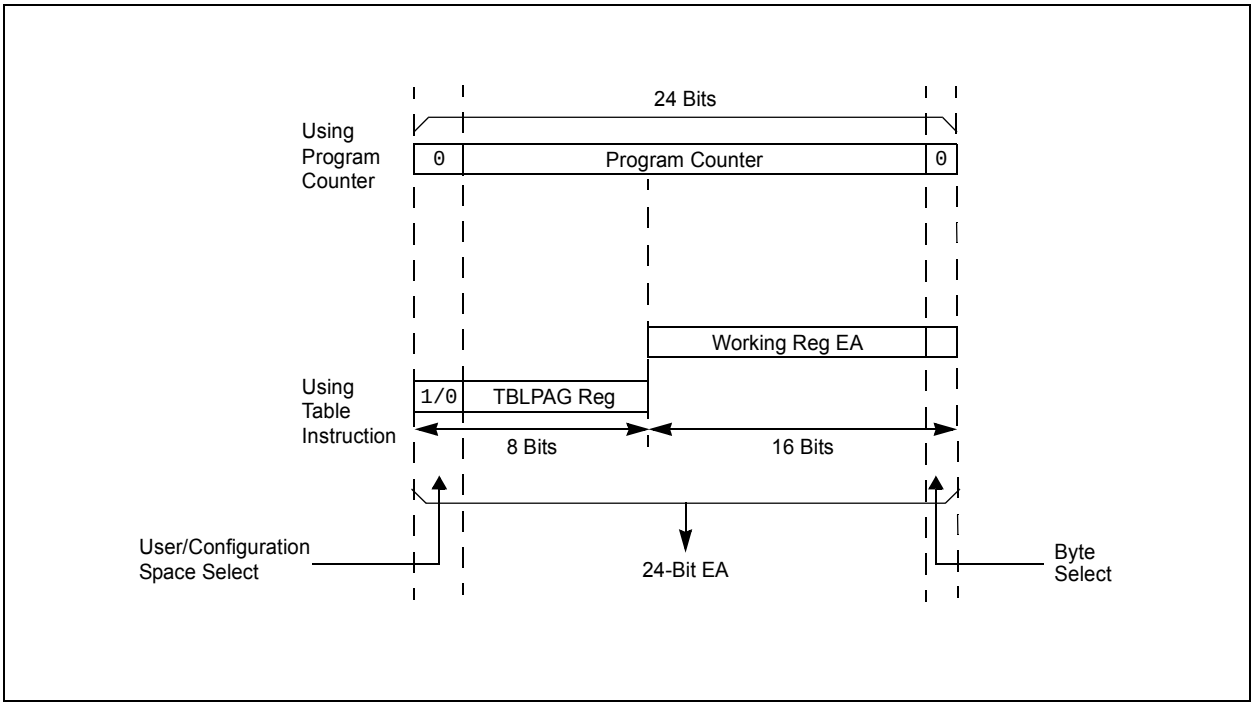
5.1 Table Instructions and Flash Programming

Regardless of the method used, all programming of Flash memory is done with the table read and table write instructions. These allow direct read and write access to the program memory space from the data memory while the device is in normal operating mode. The 24-bit target address in the program memory is formed using the TBLPAG<7:0> bits and the Effective Address (EA) from a W register, specified in the table instruction, as shown in Figure 5-1.

The TBLRDL and the TBLWTL instructions are used to read or write to bits<15:0> of program memory. TBLRDL and TBLWTL can access program memory in both Word and Byte modes.

The TBLRDH and TBLWTH instructions are used to read or write to bits<23:16> of program memory. TBLRDH and TBLWTH can also access program memory in Word or Byte mode.

FIGURE 5-1: ADDRESSING FOR TABLE REGISTERS



EXAMPLE 5-2: LOADING THE WRITE BUFFERS

```
; Set up NVMCON for row programming operations
       MOV      #0x4001, W0                    ;
       MOV      W0, NVMCON                     ; Initialize NVMCON
; Set up a pointer to the first program memory location to be written
; program memory selected, and writes enabled
       MOV      #0x0000, W0                    ;
       MOV      W0, TBLPAG                     ; Initialize PM Page Boundary SFR
       MOV      #0x6000, W0                    ; An example program memory address
; Perform the TBLWT instructions to write the latches
; 0th_program_word
       MOV      #LOW_WORD_0, W2                ;
       MOV      #HIGH_BYTE_0, W3               ;
       TBLWTL   W2, [W0]                       ; Write PM low word into program latch
       TBLWTH   W3, [W0++]                     ; Write PM high byte into program latch
; 1st_program_word
       MOV      #LOW_WORD_1, W2                ;
       MOV      #HIGH_BYTE_1, W3               ;
       TBLWTL   W2, [W0]                       ; Write PM low word into program latch
       TBLWTH   W3, [W0++]                     ; Write PM high byte into program latch
; 2nd_program_word
       MOV      #LOW_WORD_2, W2                ;
       MOV      #HIGH_BYTE_2, W3               ;
       TBLWTL   W2, [W0]                       ; Write PM low word into program latch
       TBLWTH   W3, [W0++]                     ; Write PM high byte into program latch
       •
       •
       •
; 63rd_program_word
       MOV      #LOW_WORD_31, W2               ;
       MOV      #HIGH_BYTE_31, W3              ;
       TBLWTL   W2, [W0]                       ; Write PM low word into program latch
       TBLWTH   W3, [W0]                       ; Write PM high byte into program latch
```

EXAMPLE 5-3: INITIATING A PROGRAMMING SEQUENCE

```
       DISI   #5                       ; Block all interrupts with priority <7
                                       ; for next 5 instructions
       MOV    #0x55, W0
       MOV    W0, NVMKEY               ; Write the 55 key
       MOV    #0xAA, W1                ;
       MOV    W1, NVMKEY               ; Write the AA key
       BSET   NVMCON, #WR              ; Start the erase sequence
       NOP                             ; 2 NOPs required after setting WR
       NOP                             ;
       BTSC   NVMCON, #15              ; Wait for the sequence to be completed
       BRA    $-2                      ;
```

REGISTER 7-24: IPC9: INTERRUPT PRIORITY CONTROL REGISTER 9

U-0	R/W-1	R/W-0	R/W-0	U-0	R/W-1	R/W-0	R/W-0
—	IC5IP2	IC5IP1	IC5IP0	—	IC4IP2	IC4IP1	IC4IP0
bit 15							bit 8

U-0	R/W-1	R/W-0	R/W-0	U-0	U-0	U-0	U-0
—	IC3IP2	IC3IP1	IC3IP0	—	—	—	—
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as ‘0’	
-n = Value at POR	‘1’ = Bit is set	‘0’ = Bit is cleared	x = Bit is unknown

bit 15 **Unimplemented:** Read as ‘0’

bit 14-12 **IC5IP<2:0>:** Input Capture Channel 5 Interrupt Priority bits
111 = Interrupt is Priority 7 (highest priority interrupt)
•
•
•
001 = Interrupt is Priority 1
000 = Interrupt source is disabled

bit 11 **Unimplemented:** Read as ‘0’

bit 10-8 **IC4IP<2:0>:** Input Capture Channel 4 Interrupt Priority bits
111 = Interrupt is Priority 7 (highest priority interrupt)
•
•
•
001 = Interrupt is Priority 1
000 = Interrupt source is disabled

bit 7 **Unimplemented:** Read as ‘0’

bit 6-4 **IC3IP<2:0>:** Input Capture Channel 3 Interrupt Priority bits
111 = Interrupt is Priority 7 (highest priority interrupt)
•
•
•
001 = Interrupt is Priority 1
000 = Interrupt source is disabled

bit 3-0 **Unimplemented:** Read as ‘0’

REGISTER 10-23: RPOR8: PERIPHERAL PIN SELECT OUTPUT REGISTER 8

U-0	U-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
—	—	—	RP17R4(1)	RP17R3(1)	RP17R2(1)	RP17R1(1)	RP17R0(1)
bit 15							bit 8

U-0	U-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
—	—	—	RP16R4(1)	RP16R3(1)	RP16R2(1)	RP16R1(1)	RP16R0(1)
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'	
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 15-13 **Unimplemented:** Read as '0'

bit 12-8 **RP17R<4:0>:** Peripheral Output Function is Assigned to RP17 Output Pin bits(1)
(see Table 10-3 for peripheral function numbers)

bit 7-5 **Unimplemented:** Read as '0'

bit 4-0 **RP16R<4:0>:** Peripheral Output Function is Assigned to RP16 Output Pin bits(1)
(see Table 10-3 for peripheral function numbers)

Note 1: These bits are only available on the 44-pin devices; otherwise, they read as '0'.

REGISTER 10-24: RPOR9: PERIPHERAL PIN SELECT OUTPUT REGISTER 9

U-0	U-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
—	—	—	RP19R4(1)	RP19R3(1)	RP19R2(1)	RP19R1(1)	RP19R0(1)
bit 15							bit 8

U-0	U-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
—	—	—	RP18R4(1)	RP18R3(1)	RP18R2(1)	RP18R1(1)	RP18R0(1)
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'	
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 15-13 **Unimplemented:** Read as '0'

bit 12-8 **RP19R<4:0>:** Peripheral Output Function is Assigned to RP19 Output Pin bits(1)
(see Table 10-3 for peripheral function numbers)

bit 7-5 **Unimplemented:** Read as '0'

bit 4-0 **RP18R<4:0>:** Peripheral Output Function is Assigned to RP18 Output Pin bits(1)
(see Table 10-3 for peripheral function numbers)

Note 1: These bits are only available on the 44-pin devices; otherwise, they read as '0'.

REGISTER 10-25: RPOR10: PERIPHERAL PIN SELECT OUTPUT REGISTER 10

U-0	U-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
—	—	—	RP21R4(1)	RP21R3(1)	RP21R2(1)	RP21R1(1)	RP21R0(1)
bit 15							bit 8

U-0	U-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
—	—	—	RP20R4(1)	RP20R3(1)	RP20R2(1)	RP20R1(1)	RP20R0(1)
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'	
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 15-13 **Unimplemented:** Read as '0'

bit 12-8 **RP21R<4:0>:** Peripheral Output Function is Assigned to RP21 Output Pin bits(1)
(see Table 10-3 for peripheral function numbers)

bit 7-5 **Unimplemented:** Read as '0'

bit 4-0 **RP20R<4:0>:** Peripheral Output Function is Assigned to RP20 Output Pin bits(1)
(see Table 10-3 for peripheral function numbers)

Note 1: These bits are only available on the 44-pin devices; otherwise, they read as '0'.

REGISTER 10-26: RPOR11: PERIPHERAL PIN SELECT OUTPUT REGISTER 11

U-0	U-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
—	—	—	RP23R4(1)	RP23R3(1)	RP23R2(1)	RP23R1(1)	RP23R0(1)
bit 15							bit 8

U-0	U-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
—	—	—	RP22R4(1)	RP22R3(1)	RP22R2(1)	RP22R1(1)	RP22R0(1)
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'	
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 15-13 **Unimplemented:** Read as '0'

bit 12-8 **RP23R<4:0>:** Peripheral Output Function is Assigned to RP23 Output Pin bits(1)
(see Table 10-3 for peripheral function numbers)

bit 7-5 **Unimplemented:** Read as '0'

bit 4-0 **RP22R<4:0>:** Peripheral Output Function is Assigned to RP22 Output Pin bits(1)
(see Table 10-3 for peripheral function numbers)

Note 1: These bits are only available on the 44-pin devices; otherwise, they read as '0'.

11.0 TIMER1

Note: This data sheet summarizes the features of this group of PIC24F devices. It is not intended to be a comprehensive reference source. For more information, refer to the *"PIC24F Family Reference Manual"*, **"Timers"** (DS39704).

The Timer1 module is a 16-bit timer which can serve as the time counter for the Real-Time Clock (RTC), or operate as a free-running, interval timer/counter. Timer1 can operate in three modes:

- 16-Bit Timer
- 16-Bit Synchronous Counter
- 16-Bit Asynchronous Counter

Timer1 also supports these features:

- Timer Gate Operation
- Selectable Prescaler Settings
- Timer Operation During CPU Idle and Sleep modes
- Interrupt on 16-Bit Period Register Match or Falling Edge of External Gate Signal

Figure 11-1 presents a block diagram of the 16-bit timer module.

To configure Timer1 for operation:

1. Set the TON bit (= 1).
2. Select the timer prescaler ratio using the TCKPS<1:0> bits.
3. Set the Clock and Gating modes using the TCS and TGATE bits.
4. Set or clear the TSYNC bit to configure synchronous or asynchronous operation.
5. Load the timer period value into the PR1 register.
6. If interrupts are required, set the Timer1 Interrupt Enable bit, T1IE. Use the priority bits, T1IP<2:0>, to set the interrupt priority.

FIGURE 11-1: 16-BIT TIMER1 MODULE BLOCK DIAGRAM

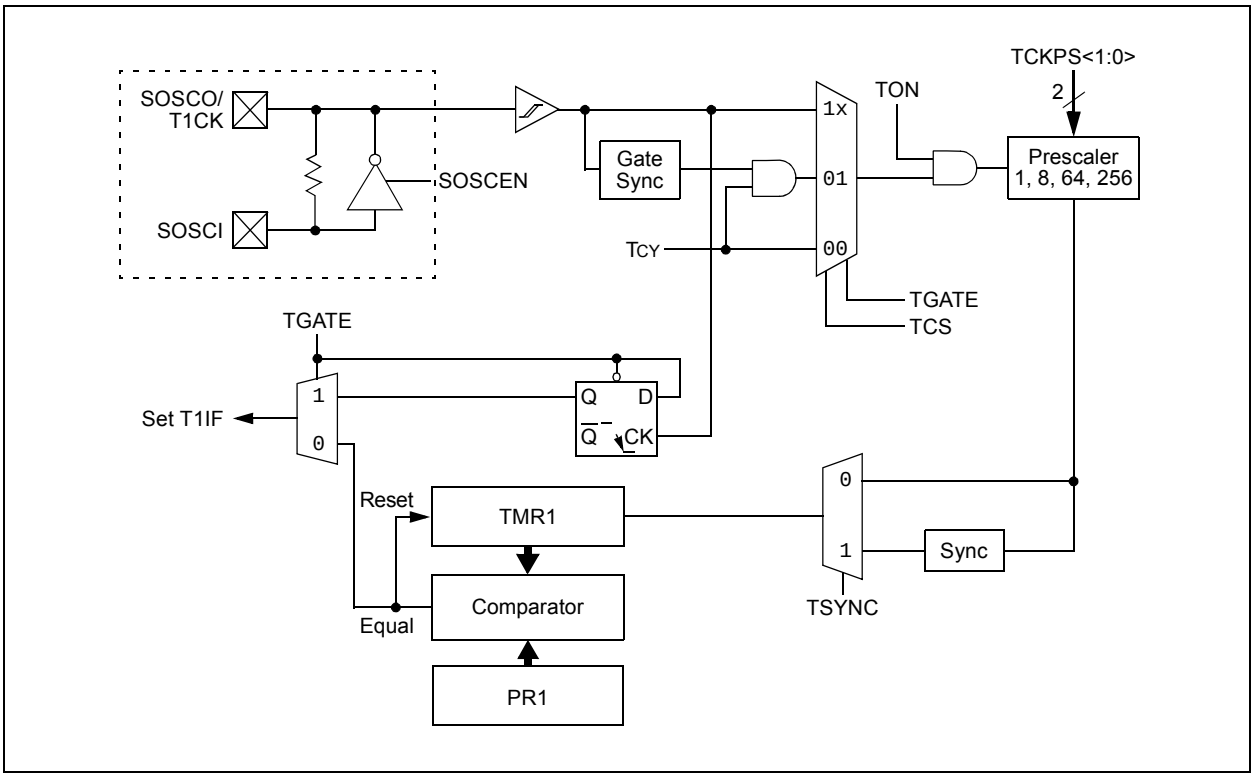
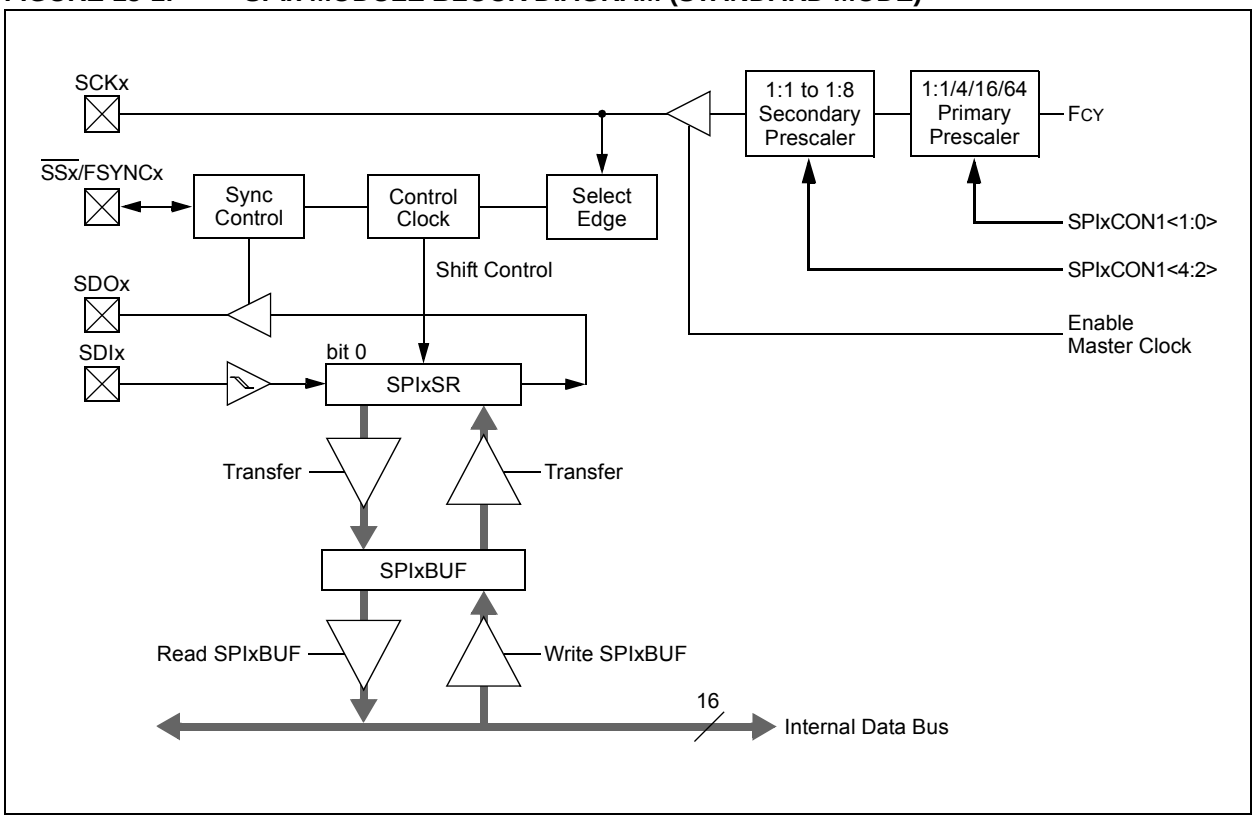


FIGURE 15-1: SPIx MODULE BLOCK DIAGRAM (STANDARD MODE)



EQUATION 15-1: RELATIONSHIP BETWEEN DEVICE AND SPIx CLOCK SPEED(1)

$$F_{SCK} = \frac{F_{CY}}{\text{Primary Prescaler} * \text{Secondary Prescaler}}$$

Note 1: Based on FCY = FOSC/2; Doze mode and PLL are disabled.

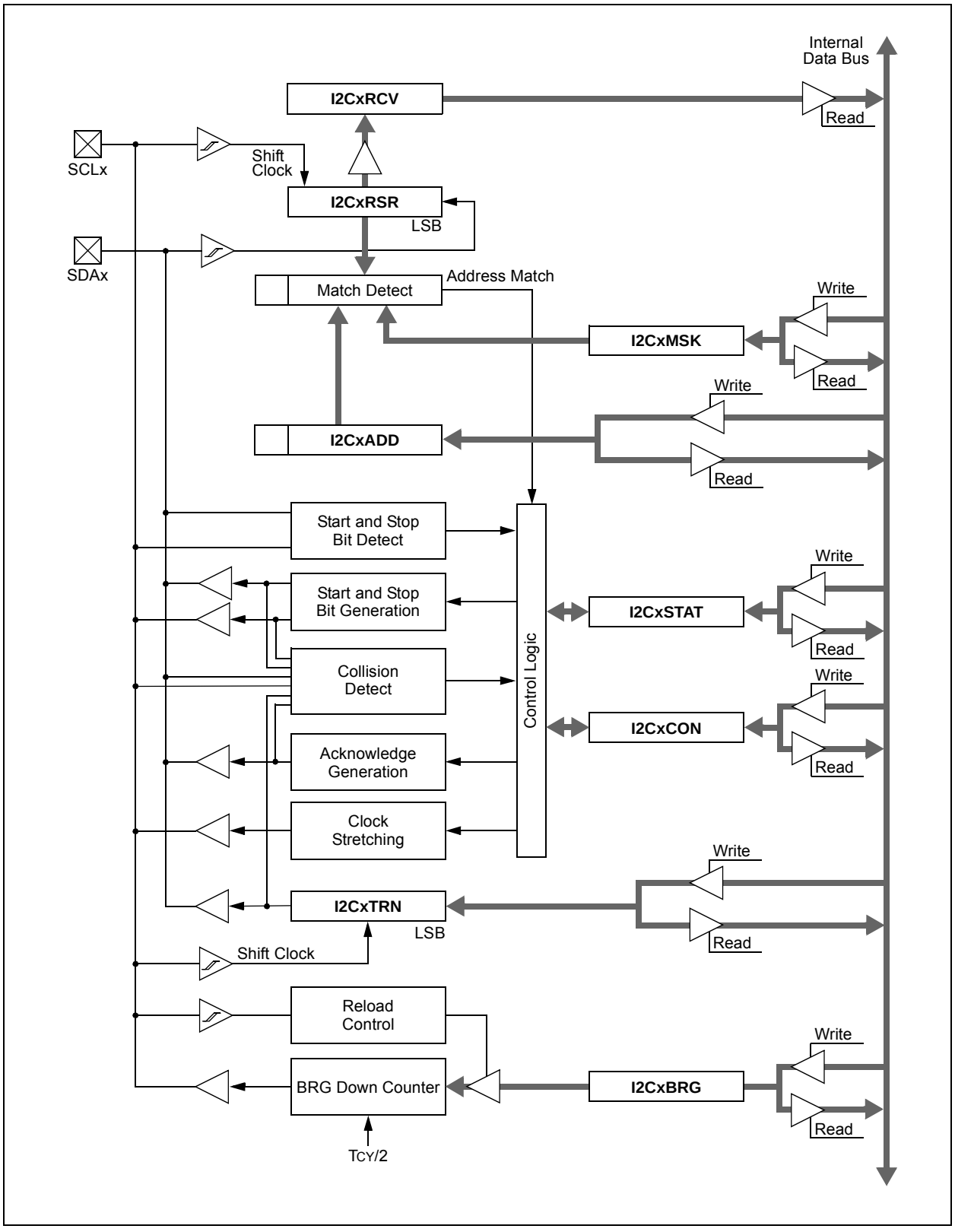
TABLE 15-1: SAMPLE SCKx FREQUENCIES(1,2)

FCY = 16 MHz		Secondary Prescaler Settings				
		1:1	2:1	4:1	6:1	8:1
Primary Prescaler Settings	1:1	Invalid	8000	4000	2667	2000
	4:1	4000	2000	1000	667	500
	16:1	1000	500	250	167	125
	64:1	250	125	63	42	31
FCY = 5 MHz						
Primary Prescaler Settings	1:1	5000	2500	1250	833	625
	4:1	1250	625	313	208	156
	16:1	313	156	78	52	39
	64:1	78	39	20	13	10

Note 1: Based on FCY = FOSC/2; Doze mode and PLL are disabled.

2: SCKx frequencies are shown in kHz.

FIGURE 16-1: I²C™ BLOCK DIAGRAM



REGISTER 17-3: UxTXREG: UARTx TRANSMIT REGISTER

U-x	U-x	U-x	U-x	U-x	U-x	U-x	W-x
—	—	—	—	—	—	—	UTX8
bit 15							bit 8

W-x	W-x	W-x	W-x	W-x	W-x	W-x	W-x
UTX7	UTX6	UTX5	UTX4	UTX3	UTX2	UTX1	UTX0
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'	
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 15-9 **Unimplemented:** Read as '0'

bit 8 **UTX8:** UARTx Data of the Transmitted Character bit (in 9-bit mode)

bit 7-0 **UTX<7:0>:** UARTx Data of the Transmitted Character bits

REGISTER 17-4: UxRXREG: UARTx RECEIVE REGISTER

U-0	U-0	U-0	U-0	U-0	U-0	U-0	R-0
—	—	—	—	—	—	—	URX8
bit 15							bit 8

R-0	R-0	R-0	R-0	R-0	R-0	R-0	R-0
URX7	URX6	URX5	URX4	URX3	URX2	URX1	URX0
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'	
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 15-9 **Unimplemented:** Read as '0'

bit 8 **URX8:** UARTx Data of the Received Character bit (in 9-bit mode)

bit 7-0 **URX<7:0>:** UARTx Data of the Received Character bits

FIGURE 18-5: MASTER MODE, PARTIALLY MULTIPLEXED ADDRESSING (SEPARATE READ AND WRITE STROBES, SINGLE CHIP SELECT)

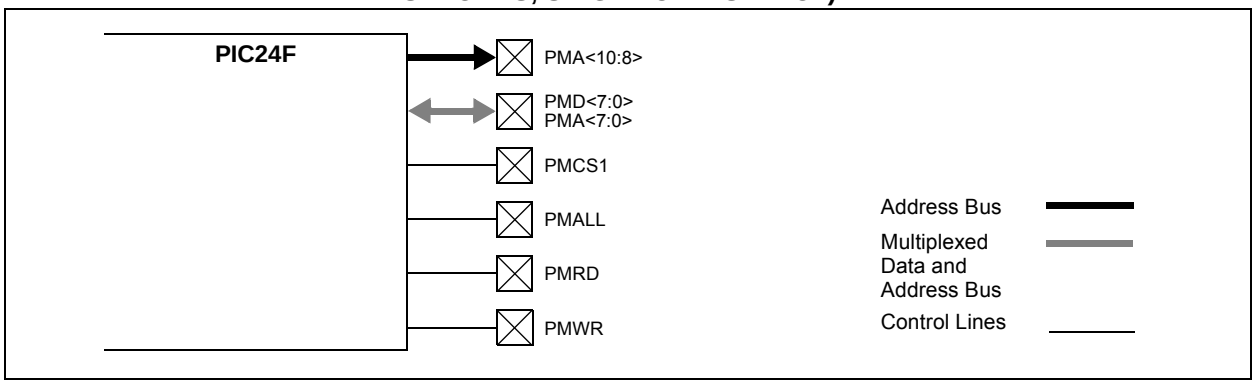


FIGURE 18-6: MASTER MODE, FULLY MULTIPLEXED ADDRESSING (SEPARATE READ AND WRITE STROBES, SINGLE CHIP SELECT)

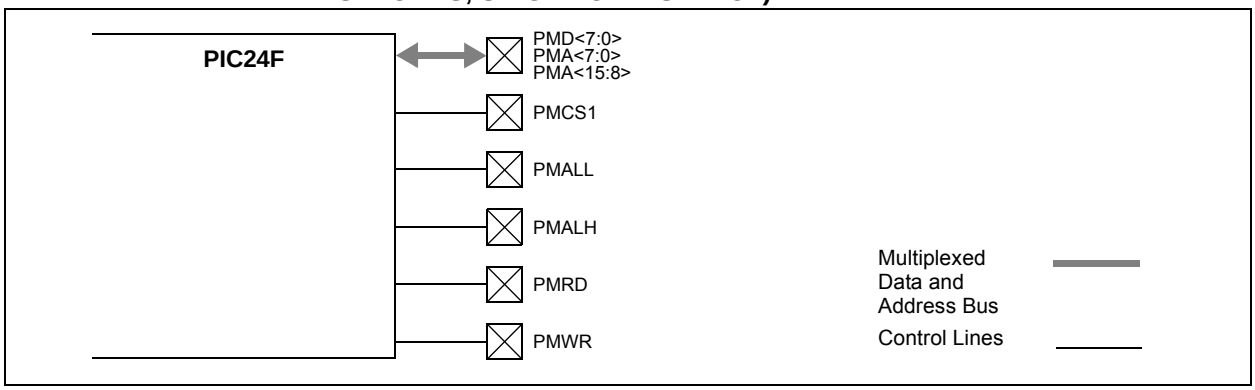


FIGURE 18-7: EXAMPLE OF A MULTIPLEXED ADDRESSING APPLICATION

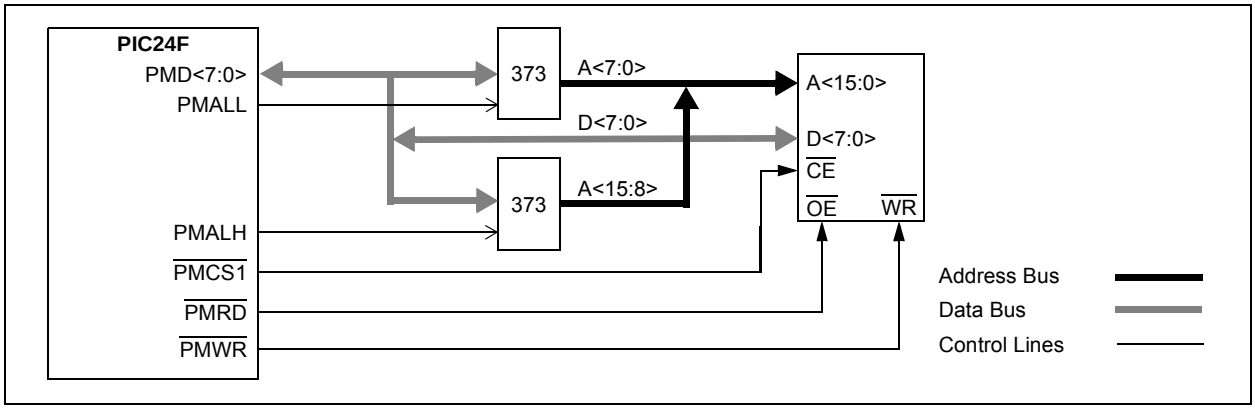
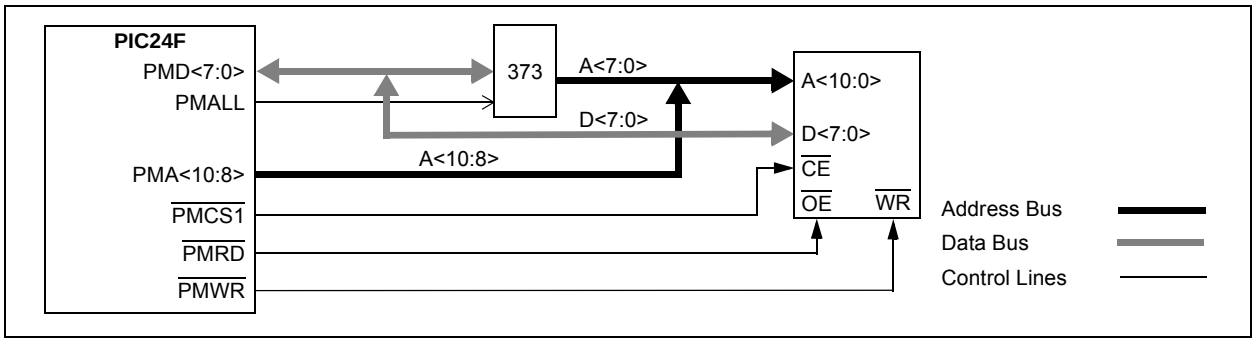


FIGURE 18-8: EXAMPLE OF A PARTIALLY MULTIPLEXED ADDRESSING APPLICATION



21.0 10-BIT HIGH-SPEED A/D CONVERTER

Note: This data sheet summarizes the features of this group of PIC24F devices. It is not intended to be a comprehensive reference source. For more information, refer to the *"PIC24F Family Reference Manual"*, **"10-Bit A/D Converter"** (DS39705).

The 10-bit A/D Converter has the following key features:

- Successive Approximation (SAR) conversion
- Conversion speeds of up to 500 ksps
- Up to 13 analog input pins
- External voltage reference input pins
- Automatic Channel Scan mode
- Selectable conversion trigger source
- 16-word conversion result buffer
- Selectable Buffer Fill modes
- Four result alignment options
- Operation during CPU Sleep and Idle modes

Depending on the particular device pinout, the 10-bit A/D Converter can have up to three analog input pins, designated AN0 through AN12. In addition, there are two analog input pins for external voltage reference connections. These voltage reference inputs may be shared with other analog input pins. The actual number of analog input pins and the external voltage reference input configuration will depend on the specific device.

A block diagram of the A/D Converter is shown in Figure 21-1.

To perform an A/D conversion:

1. Configure the A/D module:
   a) Select the port pins as analog inputs (AD1PCFG<15:0>).
   b) Select the voltage reference source to match the expected range on the analog inputs (AD1CON2<15:13>).
   c) Select the analog conversion clock to match the desired data rate with the processor clock (AD1CON3<7:0>).
   d) Select the appropriate sample/conversion sequence (AD1CON1<7:5> and AD1CON3<12:8>).
   e) Select how conversion results are presented in the buffer (AD1CON1<9:8>).
   f) Select the interrupt rate (AD1CON2<5:2>).
   g) Turn on the A/D module (AD1CON1<15>).
2. Configure the A/D interrupt (if required):
   a) Clear the AD1IF bit.
   b) Select the A/D interrupt priority.

TABLE 26-1: SYMBOLS USED IN OPCODE DESCRIPTIONS

Field	Description
#text	Means literal defined by "text"
(text)	Means "content of text"
[text]	Means "the location addressed by text"
{ }	Optional field or operation
<n:m>	Register bit field
.b	Byte mode selection
.d	Double-Word mode selection
.S	Shadow register select
.w	Word mode selection (default)
bit4	4-bit bit selection field (used in word addressed instructions) ∈ {0...15}
C, DC, N, OV, Z	MCU Status bits: Carry, Digit Carry, Negative, Overflow, Sticky Zero
Expr	Absolute address, label or expression (resolved by the linker)
f	File register address ∈ {0000h...1FFFh}
lit1	1-bit unsigned literal ∈ {0,1}
lit4	4-bit unsigned literal ∈ {0...15}
lit5	5-bit unsigned literal ∈ {0...31}
lit8	8-bit unsigned literal ∈ {0...255}
lit10	10-bit unsigned literal ∈ {0...255} for Byte mode, {0:1023} for Word mode
lit14	14-bit unsigned literal ∈ {0...16384}
lit16	16-bit unsigned literal ∈ {0...65535}
lit23	23-bit unsigned literal ∈ {0...8388608}; LSB must be '0'
None	Field does not require an entry, may be blank
PC	Program Counter
Slit10	10-bit signed literal ∈ {-512...511}
Slit16	16-bit signed literal ∈ {-32768...32767}
Slit6	6-bit signed literal ∈ {-16...16}
Wb	Base W register ∈ {W0..W15}
Wd	Destination W register ∈ { Wd, [Wd], [Wd++], [Wd--], [++Wd], [--Wd] }
Wdo	Destination W register ∈ { Wnd, [Wnd], [Wnd++], [Wnd--], [++Wnd], [--Wnd], [Wnd+Wb] }
Wm,Wn	Dividend, Divisor working register pair (direct addressing)
Wn	One of 16 working registers ∈ {W0..W15}
Wnd	One of 16 destination working registers ∈ {W0..W15}
Wns	One of 16 source working registers ∈ {W0..W15}
WREG	W0 (working register used in file register instructions)
Ws	Source W register ∈ { Ws, [Ws], [Ws++], [Ws--], [++Ws], [--Ws] }
Wso	Source W register ∈ { Wns, [Wns], [Wns++], [Wns--], [++Wns], [--Wns], [Wns+Wb] }

TABLE 27-7: DC CHARACTERISTICS: I/O PIN INPUT SPECIFICATIONS (CONTINUED)

DC CHARACTERISTICS			Standard Operating Conditions: 2.0V to 3.6V (unless otherwise stated) Operating temperature -40°C ≤ TA ≤ +85°C for Industrial -40°C ≤ TA ≤ +125°C for Extended				
Param No.	**Sym**	**Characteristic**	**Min**	**Typ(1)**	**Max**	**Units**	**Conditions**
DI31	IPU	**Maximum Load Current for Digital High Detection with Internal Pull-up**	—	—	30	µA	VDD = 2.0V
			—	—	100	µA	VDD = 3.3V
	IIL	**Input Leakage Current(2,3)**					
DI50		I/O Ports	—	—	±1	µA	VSS ≤ VPIN ≤ VDD, Pin at high-impedance
DI51		Analog Input Pins	—	—	±1	µA	VSS ≤ VPIN ≤ VDD, Pin at high-impedance
DI55		$\overline{\text{MCLR}}$	—	—	±1	µA	VSS ≤ VPIN ≤ VDD
DI56		OSCI	—	—	±1	µA	VSS ≤ VPIN ≤ VDD, XT and HS modes
DI60a	IICL	**Input Low Injection Current**	0	—	-5(5,8)	mA	All pins except VDD, VSS, AVDD, AVSS, $\overline{\text{MCLR}}$, VCAP, RB11, SOSCI, SOSCO, D+, D-, VUSB, and VBUS
DI60b	IICH	**Input High Injection Current**	0	—	+5(6,7,8)	mA	All pins except VDD, VSS, AVDD, AVSS, $\overline{\text{MCLR}}$, VCAP, RB11, SOSCI, SOSCO, D+, D-, VUSB, and VBUS, and all 5V tolerant pins(7)
DI60c	∑IICT	**Total Input Injection Current** (sum of all I/O and control pins)	-20(9)	—	+20(9)	mA	Absolute instantaneous sum of all ± input injection currents from all I/O pins (| IICL + | IICH |) ≤ ∑IICT)

Note 1: Data in "Typ" column is at 3.3V, +25°C unless otherwise stated. Parameters are for design guidance only and are not tested.

2: The leakage current on the $\overline{\text{MCLR}}$ pin is strongly dependent on the applied voltage level. The specified levels represent normal operating conditions. Higher leakage current may be measured at different input voltages.

3: Negative current is defined as current sourced by the pin.

4: Refer to Table 1-2 for I/O pin buffer types.

5: Parameter is characterized but not tested.

6: Non-5V tolerant pins, VIH source > (VDD + 0.3), 5V tolerant pins VIH source > 5.5V. Characterized but not tested.

7: Digital 5V tolerant pins cannot tolerate any "positive" input injection current from input sources greater than 5.5V.

8: Injection currents > | 0 | can affect the performance of all analog peripherals (e.g., A/D, comparators, internal band gap reference, etc.)

9: Any number and/or combination of I/O pins not excluded under IICL or IICH conditions are permitted provided the mathematical "absolute instantaneous" sum of the input injection currents from all pins do not exceed the specified limit. Characterized but not tested.

FIGURE 27-4: EXTERNAL CLOCK TIMING

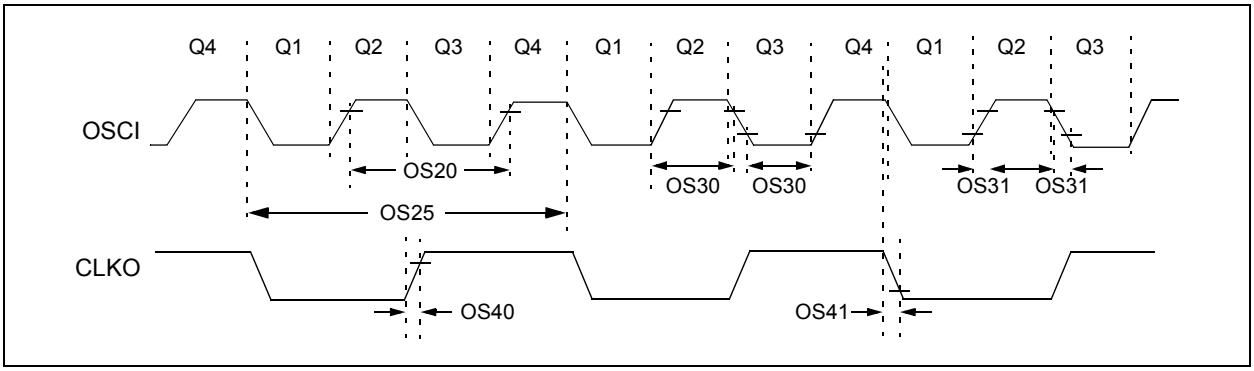


TABLE 27-15: EXTERNAL CLOCK TIMING REQUIREMENTS

AC CHARACTERISTICS			Standard Operating Conditions: 2.0 to 3.6V (unless otherwise stated) Operating temperature -40°C ≤ TA ≤ +85°C for Industrial -40°C ≤ TA ≤ +125°C for Extended				
Param No.	**Sym**	**Characteristic**	**Min**	**Typ(1)**	**Max**	**Units**	**Conditions**
OS10	FOSC	External CLKI Frequency (External clocks allowed only in EC mode)	DC	—	32	MHz	EC, -40°C ≤ TA ≤ +85°C
			4	—	8	MHz	ECPLL, -40°C ≤ TA ≤ +85°C
			DC	—	24	MHz	EC, -40°C ≤ TA ≤ +125°C
			4	—	6	MHz	ECPLL, -40°C ≤ TA ≤ +125°C
		Oscillator Frequency	3	—	10	MHz	XT
			3	—	8	MHz	XTPLL, -40°C ≤ TA ≤ +85°C
			10	—	32	MHz	HS, -40°C ≤ TA ≤ +85°C
			31	—	33	kHz	SOSC
			3	—	6	MHz	XTPLL, -40°C ≤ TA ≤ +125°C
			10	—	24	MHz	HS, -40°C ≤ TA ≤ +125°C
OS20	TOSC	TOSC = 1/FOSC	—	—	—	—	See Parameter OS10 for FOSC value
OS25	TCY	Instruction Cycle Time(2)	62.5	—	DC	ns	
OS30	TosL, TosH	External Clock In (OSCI) High or Low Time	0.45 x TOSC	—	—	ns	EC
OS31	TosR, TosF	External Clock In (OSCI) Rise or Fall Time	—	—	20	ns	EC
OS40	TckR	CLKO Rise Time(3)	—	6	10	ns	
OS41	TckF	CLKO Fall Time(3)	—	6	10	ns	

Note 1: Data in "Typ" column is at 3.3V, +25°C unless otherwise stated. Parameters are for design guidance only and are not tested.

2: Instruction cycle period (TCY) equals two times the input oscillator time base period. All specified values are based on characterization data for that particular oscillator type, under standard operating conditions, with the device executing code. Exceeding these specified limits may result in an unstable oscillator operation and/or higher than expected current consumption. All devices are tested to operate at "Min." values with an external clock applied to the OSCI/CLKI pin. When an external clock input is used, the "Max." cycle time limit is "DC" (no clock) for all devices.

3: Measurements are taken in EC mode. The CLKO signal is measured on the OSCO pin. CLKO is low for the Q1-Q2 period (1/2 TCY) and high for the Q3-Q4 period (1/2 TCY).

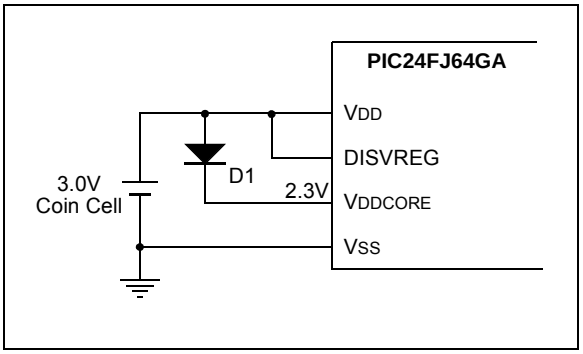
APPENDIX B: ADDITIONAL GUIDANCE FOR PIC24FJ64GA004 FAMILY APPLICATIONS

B.1 Additional Methods for Power Reduction

Devices in the PIC24FJ64GA004 family include a number of core features to significantly reduce the application's power requirements. For truly power-sensitive applications, it is possible to further reduce the application's power demands by taking advantage of the device's regulator architecture. These methods help decrease power in two ways: by disabling the internal voltage regulator to eliminate its power consumption, and by reducing the voltage on VDDCORE to lower the device's dynamic current requirements. Using these methods, it is possible to reduce Sleep currents (IPD) from 3.5 μA to 250 nA (typical values, refer to Parameters DC60d and DC60g in Table 27-6). For dynamic power consumption, the reduction in VDDCORE from 2.5V provided by the regulator, to 2.0V, can provide a power reduction of about 30%.

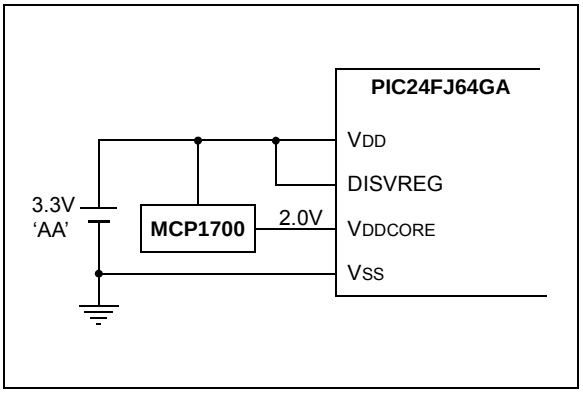
When using a regulated power source or a battery with a constant output voltage, it is possible to decrease power consumption by disabling the regulator. In this case (Figure B-1), a simple diode can be used to reduce the voltage from 3V or greater to the 2V-2.5V required for VDDCORE. This method is only advised on power supplies, such as Lithium Coin cells, which maintain a constant voltage over the life of the battery.

FIGURE B-1: POWER REDUCTION EXAMPLE FOR CONSTANT VOLTAGE SUPPLIES



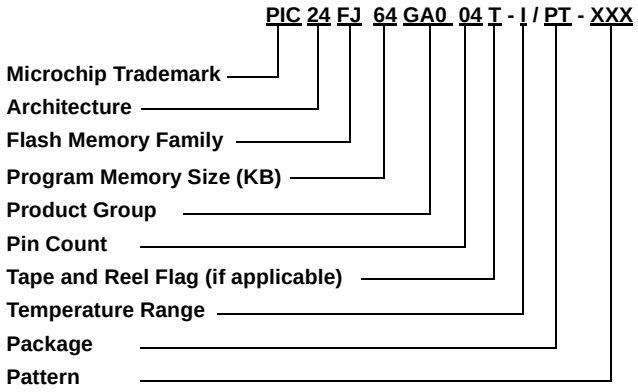
A similar method can be used for non-regulated sources (Figure B-2). In this case, it can be beneficial to use a low quiescent current, external voltage regulator. Devices, such as the MCP1700, consume only 1 μA to regulate to 2V or 2.5V, which is lower than the current required to power the internal voltage regulator.

FIGURE B-2: POWER REDUCTION EXAMPLE FOR NON-REGULATED SUPPLIES



PRODUCT IDENTIFICATION SYSTEM

To order or obtain information, e.g., on pricing or delivery, refer to the factory or the listed sales office.



Architecture	24	= 16-bit modified Harvard without DSP
Flash Memory Family	FJ	= Flash program memory
Product Group	GA0	= General purpose microcontrollers
Pin Count	02 04	= 28-pin = 44-pin
Temperature Range	E I	= -40°C to +125°C (Extended) = -40°C to +85°C (Industrial)
Package	SP SO SS ML PT	= SPDIP = SOIC = SSOP = QFN = TQFP
Pattern	Three-digit QTP, SQTP, Code or Special Requirements (blank otherwise) ES = Engineering Sample	

Examples:

a) PIC24FJ32GA002-I/ML:
General Purpose PIC24F, 32-Kbyte Program Memory, 28-Pin, Industrial Temp., QFN Package.

b) PIC24FJ64GA004-E/PT:
General Purpose PIC24F, 64-Kbyte Program Memory, 44-Pin, Extended Temp., TQFP Package.